

# SN54AS821A, SN74AS821A 10-BIT BUS-INTERFACE FLIP-FLOPS WITH 3-STATE OUTPUTS

SDAS230A – DECEMBER 1983 – REVISED AUGUST 1995

- Functionally Equivalent to AMD's AM29821
- Provide Extra Data Width Necessary for Wider Address/Data Paths or Buses With Parity
- Outputs Have Undershoot-Protection Circuitry
- Power-Up High-Impedance State
- Buffered Control Inputs to Reduce dc Loading Effects
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (NT) and Ceramic (JT) 300-mil DIPs

## description

These 10-bit flip-flops feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing wider buffer registers, I/O ports, bidirectional bus drivers with parity, and working registers.

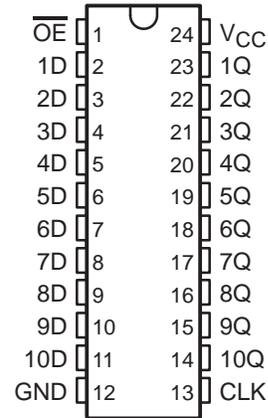
The ten flip-flops are edge-triggered D-type flip-flops. On the positive transition of the clock (CLK) input, the Q outputs are true to the data (D) input.

A buffered output-enable ( $\overline{OE}$ ) input can be used to place the ten outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

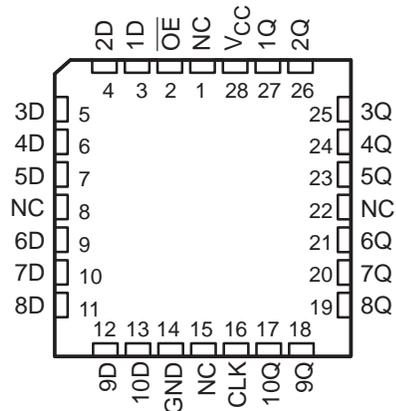
$\overline{OE}$  does not affect the internal operation of the flip-flops. Previously stored data can be retained or new data can be entered while the outputs are in the high-impedance state.

The SN54AS821A is characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ . The SN74AS821A is characterized for operation from  $0^{\circ}\text{C}$  to  $70^{\circ}\text{C}$ .

SN54AS821A . . . JT PACKAGE  
SN74AS821A . . . DW OR NT PACKAGE  
(TOP VIEW)



SN54AS821A . . . FK PACKAGE  
(TOP VIEW)



NC – No internal connection

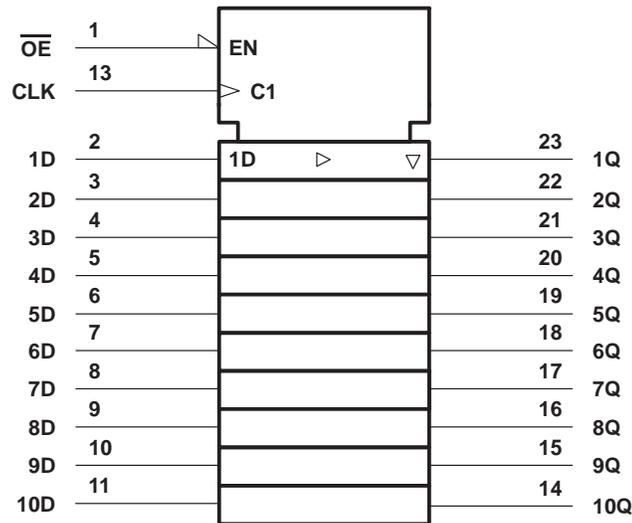
FUNCTION TABLE  
(each flip-flop)

INPUTS			OUTPUT
$\overline{OE}$	CLK	D	Q
L	$\uparrow$	H	H
L	$\uparrow$	L	L
L	L	X	$Q_0$
H	X	X	Z

# SN54AS821A, SN74AS821A 10-BIT BUS-INTERFACE FLIP-FLOPS WITH 3-STATE OUTPUTS

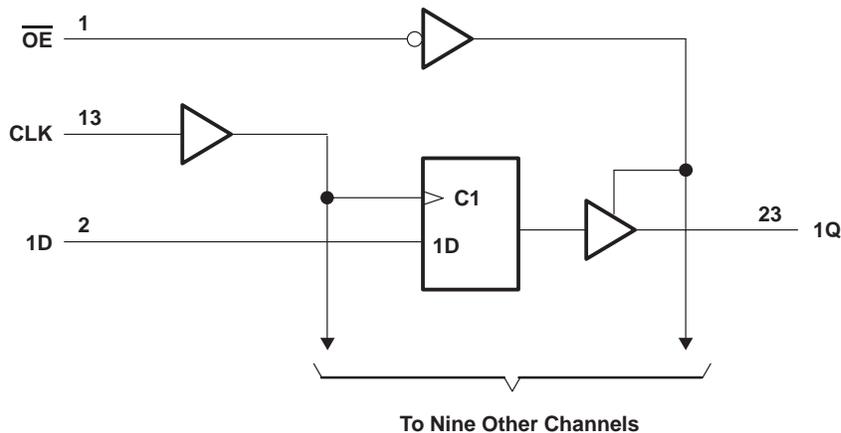
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## logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.  
Pin numbers shown are for the DW, JT, and NT packages.

## logic diagram (positive logic)



Pin numbers shown are for the DW, JT, and NT packages.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, $V_{CC}$	7 V
Input voltage, $V_I$	7 V
Voltage applied to a disabled 3-state output	5.5 V
Operating free-air temperature range, $T_A$ : SN54AS821A	-55°C to 125°C
SN74AS821A	0°C to 70°C
Storage temperature range	-65°C to 150°C

‡ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

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## recommended operating conditions

		SN54AS821A			SN74AS821A			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
$V_{CC}$	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
$V_{IH}$	High-level input voltage	2			2			V
$V_{IL}$	Low-level input voltage			0.8			0.8	V
$I_{OH}$	High-level output current			-24			-24	mA
$I_{OL}$	Low-level output current			32			48	mA
$t_w^*$	Pulse duration, CLK high or low	9			8			ns
$t_{su}^*$	Setup time, data before CLK $\uparrow$	7			6			ns
$t_h^*$	Hold time, data after CLK $\uparrow$	0			0			ns
$T_A$	Operating free-air temperature	-55		125	0		70	$^{\circ}$ C

\* On products compliant to MIL-STD-883, Class B, this parameter is based on characterization data but is not production tested.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN54AS821A			SN74AS821A			UNIT
			MIN	TYP $\dagger$	MAX	MIN	TYP $\dagger$	MAX	
$V_{IK}$	$V_{CC} = 4.5$ V,	$I_I = -18$ mA			-1.2			-1.2	V
$V_{OH}$	$V_{CC} = 4.5$ V to 5.5 V,	$I_{OH} = -2$ mA	$V_{CC} - 2$			$V_{CC} - 2$			V
	$V_{CC} = 4.5$ V	$I_{OH} = -15$ mA	2.4	3.2		2.4	3.2		
		$I_{OH} = -24$ mA	2			2			
$V_{OL}$	$V_{CC} = 4.5$ V	$I_{OL} = 32$ mA	0.25	0.5					V
		$I_{OL} = 48$ mA				0.35	0.5		
$I_{OZH}$	$V_{CC} = 5.5$ V,	$V_O = 2.7$ V			50			50	$\mu$ A
$I_{OZL}$	$V_{CC} = 5.5$ V,	$V_I = 0.4$ V			-50			-50	$\mu$ A
$I_I$	$V_{CC} = 5.5$ V,	$V_I = 7$ V			0.1			0.1	mA
$I_{IH}$	$V_{CC} = 5.5$ V,	$V_I = 2.7$ V			20			20	$\mu$ A
$I_{IL}$	$V_{CC} = 5.5$ V,	$V_I = 0.4$ V			-0.5			-0.5	mA
$I_{O\ddagger}$	$V_{CC} = 5.5$ V,	$V_O = 2.25$ V	-30		-112	-30		-112	mA
$I_{CC}$	$V_{CC} = 5.5$ V	Outputs high	55	88		55	88		mA
		Outputs low	68	109		68	109		
		Outputs disabled	70	113		70	113		

$\dagger$  All typical values are at  $V_{CC} = 5$  V,  $T_A = 25^{\circ}$ C.

$\ddagger$  The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current,  $I_{OS}$ .

**SN54AS821A, SN74AS821A**  
**10-BIT BUS-INTERFACE FLIP-FLOPS**  
**WITH 3-STATE OUTPUTS**

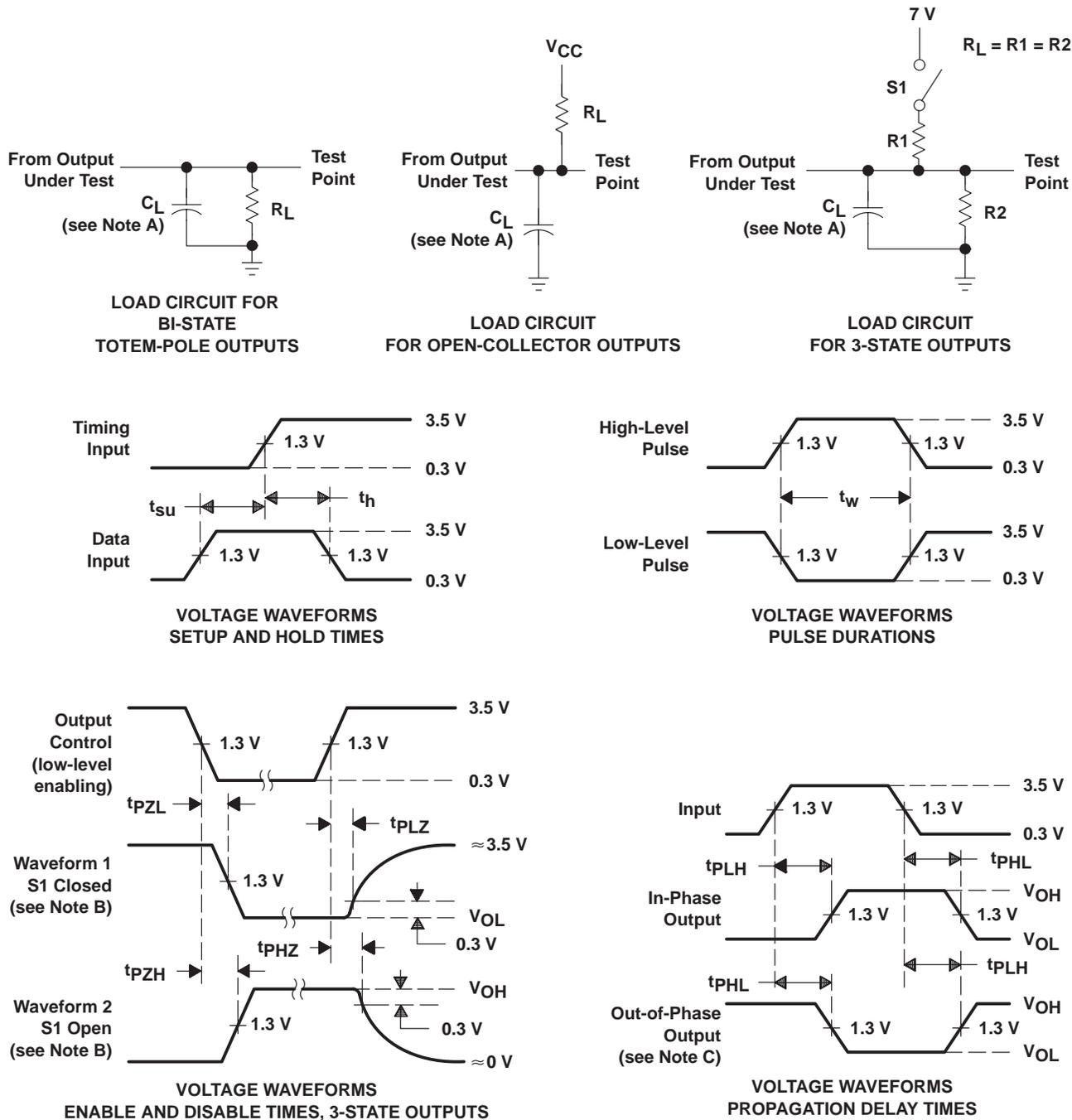
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**switching characteristics (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 4.5 V to 5.5 V, C <sub>L</sub> = 50 pF, R <sub>1</sub> = 500 Ω, R <sub>2</sub> = 500 Ω, T <sub>A</sub> = MIN to MAX†				UNIT
			SN54AS821A		SN74AS821A		
			MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	CLK	Any Q	3.5	9	3.5	7.5	ns
t <sub>PHL</sub>			3.5	14	3.5	13	
t <sub>PZH</sub>	$\overline{OE}$	Any Q	4	12	3	11	ns
t <sub>PZL</sub>			4	13	4	12	
t <sub>PHZ</sub>	$\overline{OE}$	Any Q	1	10	1	8	ns
t <sub>PLZ</sub>			1	10	1	8	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

PARAMETER MEASUREMENT INFORMATION  
SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.  
 D. All input pulses have the following characteristics: PRR  $\leq$  1 MHz,  $t_r = t_f = 2$  ns, duty cycle = 50%.  
 E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

**PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">5962-9078001MLA</a>	Active	Production	CDIP (JT)   24	15   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9078001ML A SNJ54AS821AJT
<a href="#">SN54AS821AJT</a>	Active	Production	CDIP (JT)   24	15   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54AS821AJT
SN54AS821AJT.A	Active	Production	CDIP (JT)   24	15   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54AS821AJT
<a href="#">SNJ54AS821AJT</a>	Active	Production	CDIP (JT)   24	15   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9078001ML A SNJ54AS821AJT
SNJ54AS821AJT.A	Active	Production	CDIP (JT)   24	15   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9078001ML A SNJ54AS821AJT

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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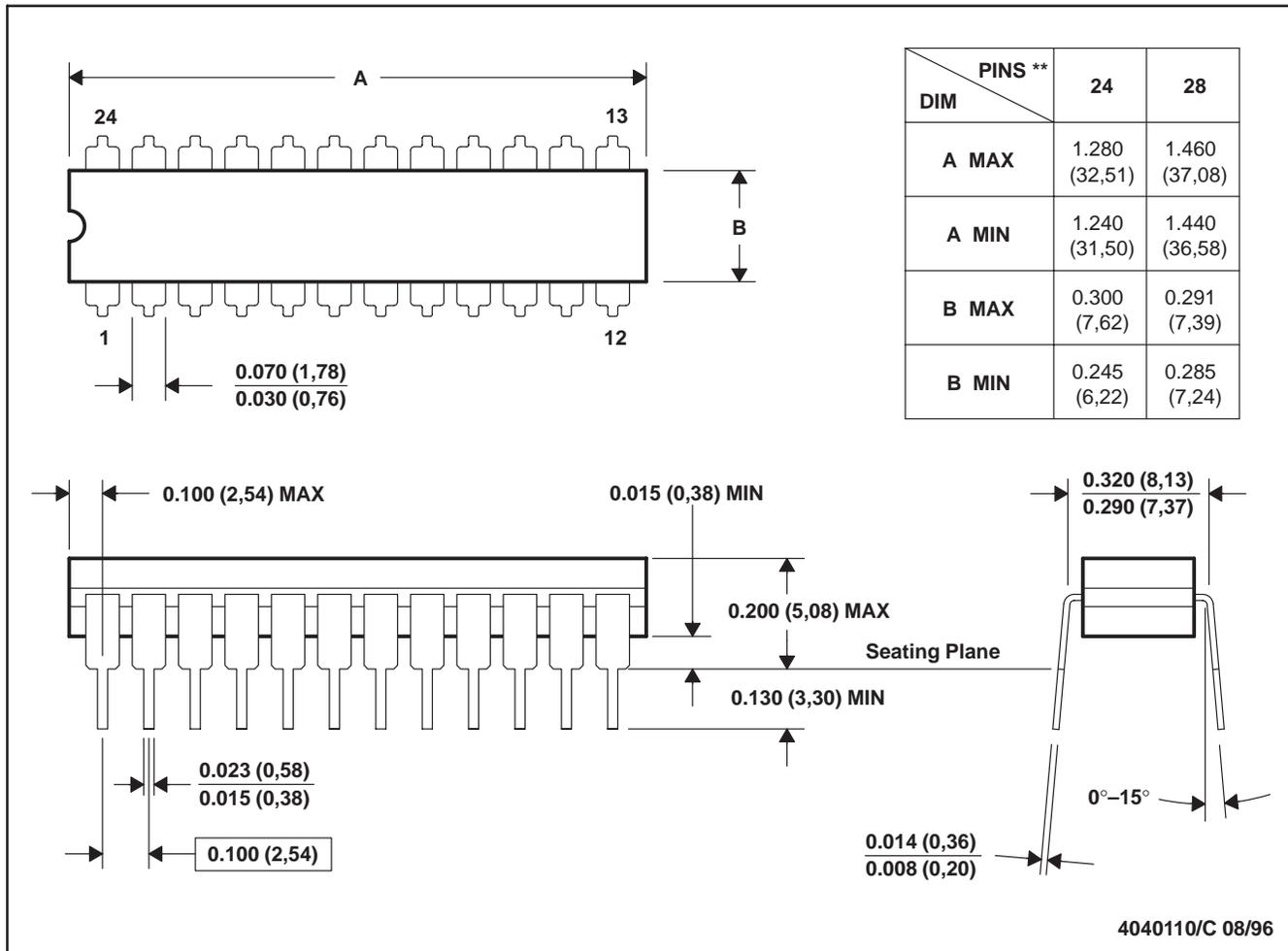
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JT (R-GDIP-T\*\*)

CERAMIC DUAL-IN-LINE

24 LEADS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package can be hermetically sealed with a ceramic lid using glass frit.  
 D. Index point is provided on cap for terminal identification.  
 E. Falls within MIL STD 1835 GDIP3-T24, GDIP4-T28, and JEDEC MO-058 AA, MO-058 AB

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